

1 Characteristics

Table 1. Absolute ratings (limiting values at 25 °C, unless otherwise specified)

Symbol	Parameter	Value	Unit	
V _{RRM}	Repetitive peak reverse voltage	600	V	
I _{F(RMS)}	Forward rms current	50	Α	
I _{F(AV)}	Average forward current δ = 0.5, square wave T_C = 120 °C		30	Α
I _{FSM}	Surge non repetitive forward current	300	Α	
T _{stg}	Storage temperature range	-65 to +175	°C	
Tj	Maximum operating junction temperature	175	°C	

Table 2. Thermal resistance parameter

Symbol	Parameter	Value	Unit
R _{th(j-c)}	Junction to case	1.1	°C/W

For more information, please refer to the following application note:

AN5088: Rectifiers thermal management, handling and mounting recommendations

Table 3. Static electrical characteristics

	Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
	I _R ⁽¹⁾	Reverse leakage current	T _j = 25 °C	$V_R = V_{RRM}$	-		25	μΑ
			T _j = 150 °C		-	80	800	
	V _F ⁽²⁾	Forward voltage drop	T _j = 25 °C	I _F = 30 A	-		1.55	V
			T _j = 150 °C		-	1.00	1.25	

- 1. Pulse test: $t_p = 5 \text{ ms}, \ \delta < 2\%$
- 2. Pulse test: t_p = 380 μ s, δ < 2%

To evaluate the conduction losses, use the following equation: $P = 0.95 \times I_{F(AV)} + 0.010 \times I_{F}^{2}$ (RMS)

For more information, please refer to the following application notes related to the power losses:

- AN604: Calculation of conduction losses in a power rectifier
- AN4021: Calculation of reverse losses in a power diode

Table 4. Dynamic characteristics

Symbol	Parameter	Test conditions			Тур.	Max.	Unit
t _{rr}	Reverse recovery time	T _i = 25 °C	I _F = 0.5 A, I _{rr} = 0.25 A, I _R = 1 A	-		65	no
		1j = 25 C	$I_F = 1 \text{ A}, V_R = 30 \text{ V}, dI_F/dt = 50 \text{ A/}\mu\text{s}$	-	65	90	ns
t _{fr}	Forward recovery time	T _j = 25 °C	$I_F = 30 \text{ A}, V_{FR} = 1.1 \text{ x } V_{Fmax}, dI_F/dt = 100 \text{ A/}\mu\text{s}$	-		500	ns
V _{FP}	Peak forward voltage	T _j = 25 °C	$I_F = 30 \text{ A}, V_{FR} = 1.1 \text{ x } V_{Fmax}, dI_F/dt = 100 \text{ A/}\mu\text{s}$	-	2.5		V
I _{RM}	Reverse recovery current	T _j = 125 °C	$I_F = 30 \text{ A}, V_R = 400 \text{ V}, dI_F/dt = 100 \text{ A}/\mu\text{s}$	-	11.5	16	Α

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1.1 Characteristics (curves)

Figure 1. Conduction losses versus average forward current

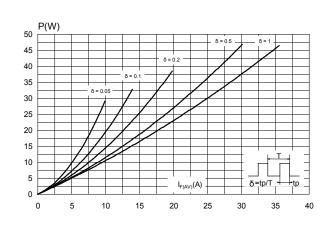


Figure 2. Forward voltage drop versus forward current

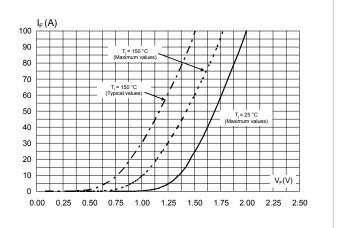


Figure 3. Relative variation of thermal impedance junction to case versus pulse duration

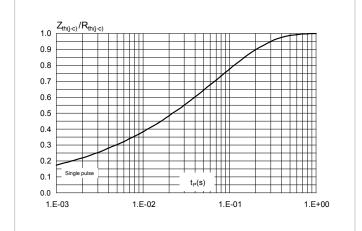
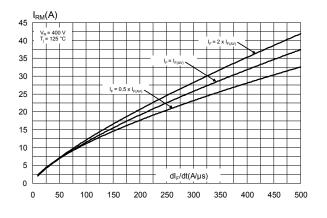


Figure 4. Peak reverse recovery current versus dl_F/dt (typical values)



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Figure 5. Reverse recovery time versus dl_F/dt (typical values)

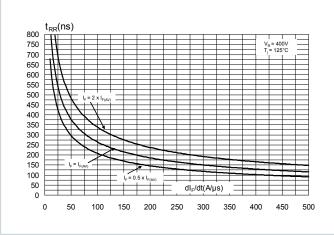


Figure 6. Reverse recovery charges versus dl_F/dt (typical values)

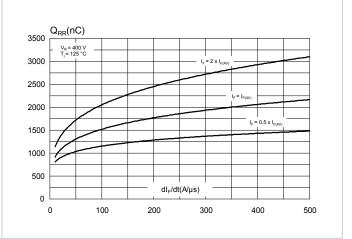


Figure 7. Reverse recovery softness factor versus dl_F/dt (typical values)

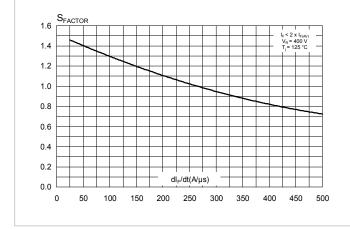


Figure 8. Relative variations of dynamic parameters versus junction temperature

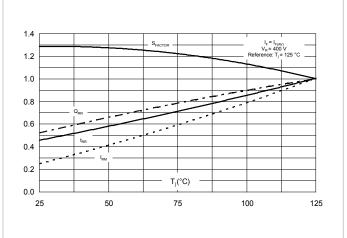


Figure 9. Transient peak forward voltage versus dl_F/dt (typical values)

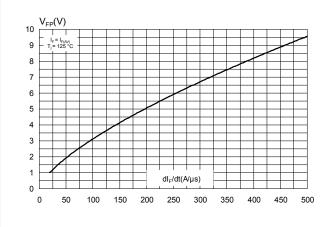
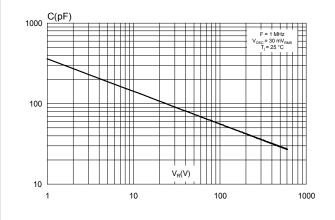


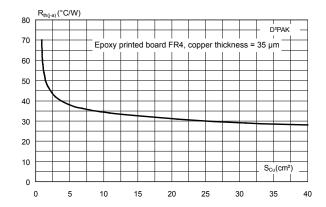
Figure 10. Junction capacitance versus reverse voltage applied (typical values)



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Figure 11. Thermal resistance, junction to ambient, versus copper surface under tab



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2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

2.1 D²PAK package information

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)

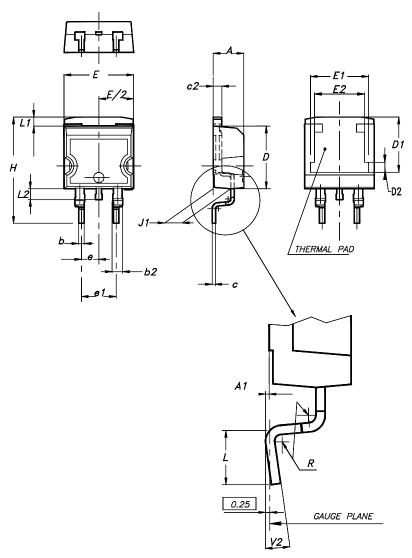


Figure 12. D²PAK package outline

Note: This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.

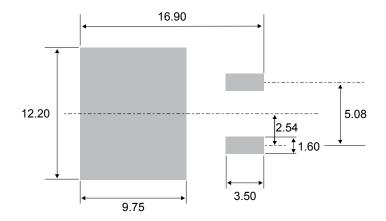
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Table 5. D²PAK package mechanical data

	Dimensions					
Ref.	Millin	neters	Inches (for reference only)			
	Min.	Max.	Min.	Max.		
Α	4.36	4.60	0.172	0.181		
A1	0.00	0.25	0.000	0.010		
b	0.70	0.93	0.028	0.037		
b2	1.14	1.70	0.045	0.067		
С	0.38	0.69	0.015	0.027		
c2	1.19	1.36	0.047	0.053		
D	8.60	9.35	0.339	0.368		
D1	6.90	8.00	0.272	0.311		
D2	1.10	1.50	0.043	0.060		
E	10.00	10.55	0.394	0.415		
E1	8.10	8.90	0.319	0.346		
E2	6.85	7.25	0.266	0.282		
е	2.54	typ.	0.100			
e1	4.88	5.28	0.190	0.205		
Н	15.00	15.85	0.591	0.624		
J1	2.49	2.90	0.097	0.112		
L	1.90	2.79	0.075	0.110		
L1	1.27	1.65	0.049	0.065		
L2	1.30	1.78	0.050	0.070		
R	0.4	typ.	0.0	15		
V2	0°	8°	0°	8°		

Figure 13. D²PAK recommended footprint (dimensions in mm)



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2.2 DO-247 package information

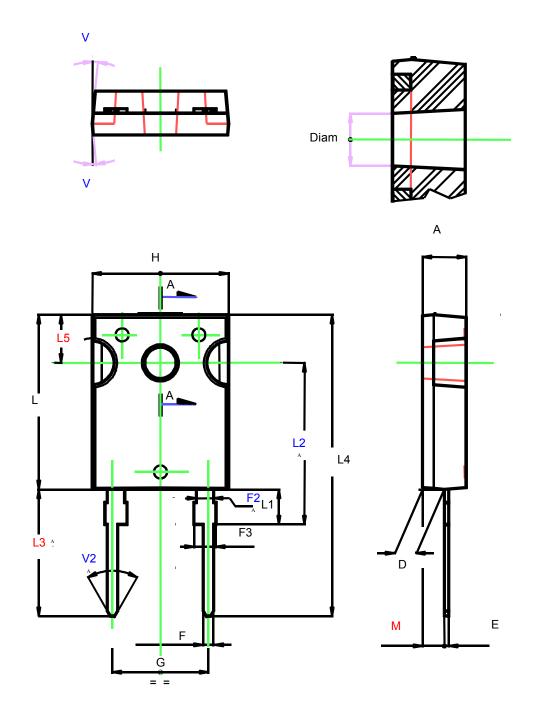
• Epoxy meets UL94, V0

• Cooling method: by conduction (C)

Recommended torque value: 0.8 N·m

• Maximum torque value: 1.0 N·m

Figure 14. DO-247 package outline



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Table 6. DO-247 package mechanical data

	Dimensions						
Ref.	Millimeters			Inches (for reference only)			
	Min.	Тур.	Max.	Min.	Тур.	Max.	
А	4.85		5.15	0.1909		0.2027	
D	2.2		2.6	0.0866		0.1023	
E	0.4		0.8	0.0157		0.0314	
F	1		1.4	0.0393		0.0551	
F2		2			0.0787		
F3	2		2.4	0.0787		0.0944	
G		10.9			0.4291		
Н	15.45		15.75	0.6082		0.6200	
L	19.85		20.15	0.7814		0.7933	
L1	3.7		4.3	0.1456		0.1692	
L2		18.5			0.7283		
L3	14.2		14.8	0.5590		0.5826	
L4		34.6			1.3622		
L5		5.5			0.2165		
M	2		3	0.0787		0.1181	
V		5°			5°		
V2		60°			60°		
Diam.	3.55		3.65	0.1397		0.1437	



3 Ordering information

Table 7. Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
STTH30L06G	STTH30L06G	D ² PAK	1.48 g	50	Tube
STTH30L06G-TR	STTH30L06G	D ² PAK	1.48 g	1000	Tape and reel
STTH30L06W	STTH30L06W	DO-247	4.40 g	30	Tube

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Revision history

Table 8. Document revision history

Date	Revision	Changes
07-Sep-2004	1	First issue.
21-Oct-2004	2	DOP3I package added.
11-Jan-06	3	On page 2: I _{F(RMS)} corrected from 30 A to 50 A I _{F(AV)} corrected from 50 A to 30 A
10-Aug-2006	4	Reformatted to current standards. SOD-93 package removed.
06-Sep-2011	5	Updated I _{FSM} from 160 A to 300 A. Removed TO-220 and DOP3I.
09-Nov-2017	6	Removed D²PAK package. Minor text change to improve readability.
10-Jan-2018	7	Updated Table 7: "Ordering information"
25-Sep-2018	8	Added D²PAK package. Updated Table 7. Ordering information. Removed figure 10.



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